

Full Color PCB Type SMD LED VAOL-S1513RGB

Features

- Package in 8mm tape on a 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- ESD Protect.
- RoHS compliant version.

Descriptions

- The SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density and reduced storage space and finally smaller equipment to be obtained.
- Light weight makes them ideal for miniature applications.

Applications

- Automotive: backlighting in dashboard and switch.
- Portable equipment.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

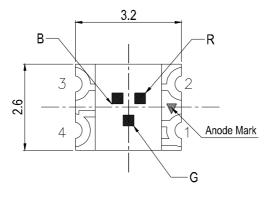
| | T 6.1 | | |
|------|----------|----------------------|-------------|
| Туре | Material | Emitted Color | Lens Color |
| R6 | AlGaInP | Brilliant Red | |
| GH | InGaN | Brilliant Green | Water Clear |
| ВН | InGaN | Blue | |

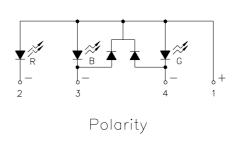


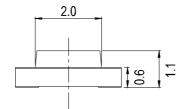




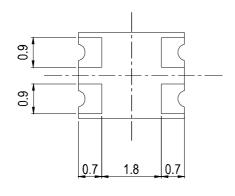
Package Outline Dimensions

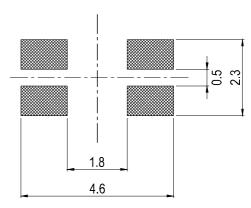






For reflow soldering (propose)





Note: The tolerances unless mentioned is ± 0.1 mm,Unit = mm







Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Rating | Unit |
|--|--------|---|-------------------------|
| Reverse Voltage | V_R | 5 | V |
| Forward Current | IF | R6:25 GH:25 BH:25 | mA |
| Operating Temperature | Topr | -40 ∼ +85 | $^{\circ}\!\mathrm{C}$ |
| Storage Temperature | Tstg | -40 ~ +90 | $^{\circ}\! C$ |
| Soldering Temperature | Tsol | 260 (for 5 seconds) | $^{\circ}\! \mathbb{C}$ |
| Electrostatic Discharge (HBM) | ESD | R6:2000 GH:2000 BH:2000 | V |
| Power Dissipation | Pd | R6:60 GH:110 BH:110 | mW |
| Peak Forward Current (Duty 1/10 @1KHz) | IFP | R6:60 GH:100 BH:100 | mA |
| Soldering Temperature | Tsol | Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec. | |

Specific binning requirements- please contact our home office







Electro-Optical Characteristics (Ta=25°C)

| Parameter Sy | | ibol | Min. | Typ. | Max. | Unit | Condition |
|---------------------------------|---------------------|------|------|------|------|---------|----------------------|
| | | R6 | 90 | 140 | | | |
| Luminous Intensity | Iv | GH | 112 | 180 | | mcd | IF=20mA |
| | | ВН | 45 | 70 | | | |
| Viewing Angle | 2 \theta 1/2 | | | 120 | | deg | I _F =20mA |
| | | R6 | | 632 | | nm | I _F =20mA |
| Peak Wavelength | λp | GH | | 518 | | | |
| | | ВН | | 468 | | | |
| | | R6 | | 624 | | | |
| Dominant Wavelength | λd | GH | | 525 | | nm | I _F =20mA |
| | | ВН | | 470 | | | |
| Carotana Dodiction | | R6 | | 20 | | | |
| Spectrum Radiation Bandwidth | $\triangle \lambda$ | GH | | 35 | | nm | I _F =20mA |
| | | ВН | | 25 | | | |
| | | R6 | 1.7 | 2.0 | 2.4 | | |
| Forward Voltage | VF | GH | 2.7 | 3.3 | 3.7 | V | I _F =20mA |
| | | ВН | 2.7 | 3.3 | 3.7 | | |
| | | R6 | | | 10 | | |
| Reverse Current | IR | GH | | | NA μ | μ A | $V_R=5V$ |
| | | ВН | | | NA | | |

Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2. Tolerance of Forward Voltage $\pm 0.05V$

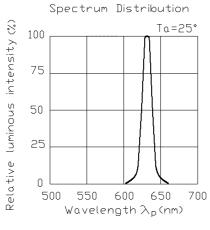


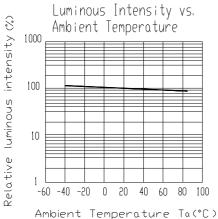


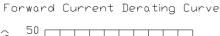


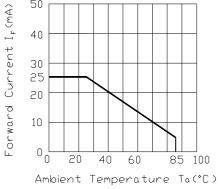
Typical Electro-Optical Characteristics Curves

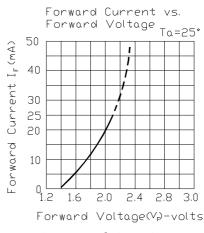
R6

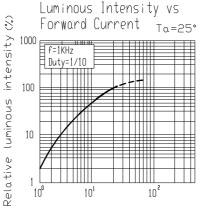


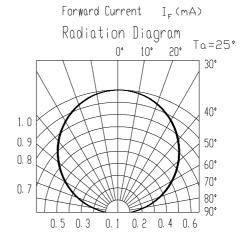










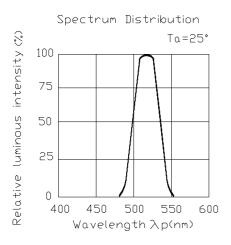


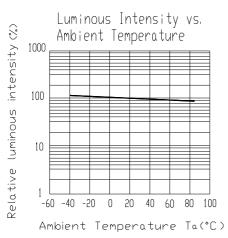


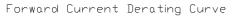


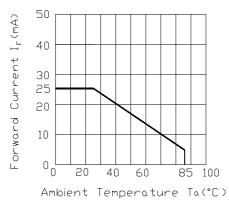
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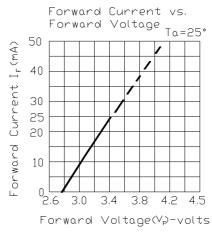
GH

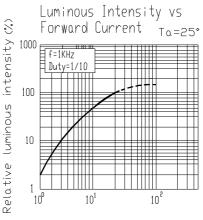


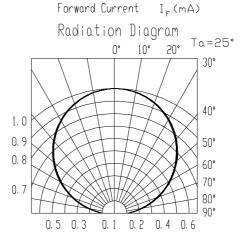












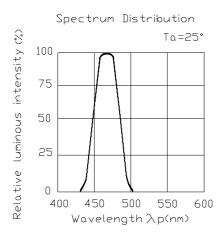


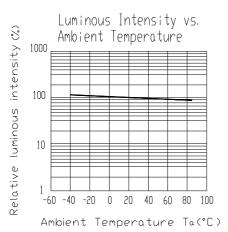


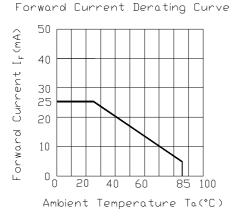


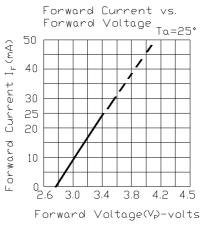
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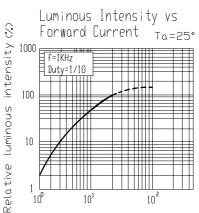
BH

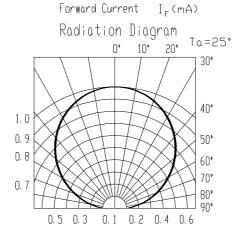










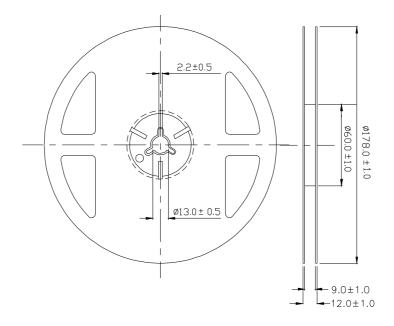








Reel Dimensions



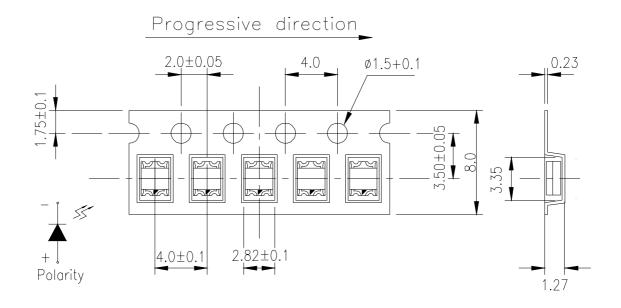
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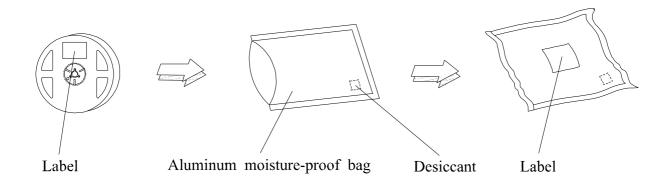


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging







Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

| No. | Items | Test Condition | Test Hours/Cycles | Sample Size | Ac/Re |
|-----|-------------------------------------|---|----------------------|----------------|-------|
| 1 | Reflow Soldering | Temp. : 260°C±5°C Min. 5sec. | 6 Min. | 22 PCS. | 0/1 |
| 2 | Temperature Cycle | $H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min | 300 Cycles | 22 PCS. | 0/1 |
| 3 | Thermal Shock | $H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min | 300 Cycles | 22 PCS. | 0/1 |
| 4 | High Temperature Storage | Temp. : 100°C | 1000 Hrs. | 22 PCS. | 0/1 |
| 5 | Low Temperature Storage | Temp. : -40°C | 1000 Hrs. | 22 PCS. | 0/1 |
| 6 | DC Operating Life | $I_F = 20 \text{ mA}$ | 1000 Hrs. | 22 PCS. | 0/1 |
| 7 | High Temperature / High Humidity | 85°C / 85%RH | 1000 Hrs. | 22 PCS. | 0/1 |





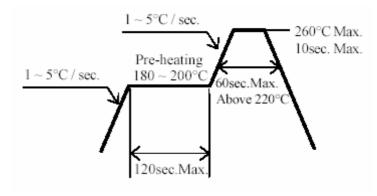
Precautions For Use

1. Customer must apply resistors for protection, otherwise a slight voltage shift will cause a big current change.

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



